

ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU Product Guide

The ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU is a general-purpose GPU optimized for media stream density and quality. It is designed for data center and edge applications, with high levels of reliability, availability, and scalability. The GPU is suitable for media processing and delivery, Windows and Android cloud gaming, virtualized desktop infrastructure (VDI), and AI visual inference applications.

The Intel Data Center GPU Flex 170 is suitable for workloads that include complex AI models, such as multiple object detection or multiple classification models. With its AI compute power, the Flex 170 GPU avoids becoming AI bound. It can support the same number of video streams per adapter as the compute requirements increase.



Figure 1. ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU

Did you know?

The Intel Flex Series GPUs support an open, flexible, standards-based software stack together with oneAPI so developers can build high-performance, cross-architecture applications and solutions. This helps organizations reduce the complexity, cost, and time requirements to bring new solutions to market, enabling engineers and programmers to innovate instead of maintaining code.

Part number information

The following table shows the ordering information for the Flex 170 GPU.

Table 1. Ordering information

Part number	Feature code	Description
4X67A86131	BU01	ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU

The option part number includes the following:

- One Flex 170 GPU with full-height (3U) adapter bracket attached
- Two extender brackets (straight, offset)
- Documentation

Features

Intel Data Center GPU Flex Series is a flexible, robust, and the industry's most open GPU solution for the intelligent visual cloud. The GPUs support a diverse range of workloads in the industry starting with media streaming and cloud gaming, followed by support for AI visual inference and virtual desktop Infrastructure workloads. It supports an open, standards-based software stack optimized for density and quality with critical server capabilities for high reliability, availability, and scalability. This helps reduce the need for data centers to use disparate solutions and manage heterogenous or proprietary environments.

The ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU offers the following features:

- **Open Architecture**
The Intel Flex Series GPU supports an open, flexible, standards-based software stack together with oneAPI so developers can build high-performance, cross-architecture applications and solutions. This helps organizations reduce the complexity, cost, and time requirements to bring new solutions to market, enabling engineers and programmers to innovate instead of maintaining code.
- **Built-In AV1 Encode**
Services built on the royalty-free open-source AV1 codec mean lowering operational expenses while providing higher video quality. Advanced video coding (AVC), High Efficiency Video Coding (HEVC), and VP9 support also comes standard with the Intel Data Center GPU.
- **No Licensing Fees**
Intel provides free virtual GPU software license to customers for lowering their total cost of ownership in VDI deployments. Furthermore, this can act as a catalyst to accelerate the GPU adoption rate in VDI deployments where graphics & encode accelerations are desired/preferred but can often be cost prohibitive.
- **Flexible vGPU Management**
The Intel Data Center GPU Flex Series supports multiple vGPU configuration & scheduling options for VDI solutions to meet different customer workload and QoS requirements—such as Linux KVM open-source virtualization technology and VMware ESXi. It also supports both VMware Horizon and Citrix DaaS† on top. The Flex Series accelerators have strong ecosystem support. The top two industry leading desktop & application virtualization solutions, VMware Horizon and Citrix DaaS, will be supported.
- **High Performance Virtual Desktop**
The Intel Data Center GPU Flex 170 is ideal for VDI deployment targeting power users persona – 3D and media content creation workloads whose graphics and compute performance requirements are high.

Technical specifications

The following table lists the specifications of the Flex 170 GPU.

Table 2. Specifications

Feature	Flex 170
GPU Architecture	X ^e HPG
GPUs per card	1
Execution units	512
Intel X ^e Cores	32
Media Engine	2
Ray Tracing	32 RT units
FP32 peak performance	16.8 TFLOPS
FP16 peak performance	128 TFLOPS
INT8 peak performance	256 TOPS
INT4 peak performance	512 TOPS
GPU Memory	16 GB ECC GDDR6
Memory Bandwidth	576 GB/s
Virtualization (SR-IOV)	31 Virtual Functions (VFs)
System Interface	PCIe Gen 4, x16 lanes
Form Factor	PCIe full-height, full-length, single width
Max Power Consumption	150 W
Thermal Solution	Passive
Encoding and decoding	<ul style="list-style-type: none"> • H.264 Hardware Encode/Decode • H.265 (HEVC) Hardware Encode/Decode • AV1 Encode/Decode • VP9 Bitstream & Decoding

Server support

The following tables list the ThinkSystem servers that are compatible.

Table 3. Server support (Part 1 of 4)

Part Number	Description	2S AMD V3				2S Intel V3				4S 8S Intel V3				Multi Node		GPU Rich		1S V3		
		SR635 V3 (7D9H / 7D9G)	SR655 V3 (7D9F / 7D9E)	SR645 V3 (7D9D / 7D9C)	SR665 V3 (7D9B / 7D9A)	ST650 V3 (7D7B / 7D7A)	SR630 V3 (7D72 / 7D73)	SR650 V3 (7D75 / 7D76)	SR850 V3 (7D97 / 7D96)	SR860 V3 (7D94 / 7D93)	SR950 V3 (7DC5 / 7DC4)	SD535 V3 (7DD8 / 7DD1)	SD530 V3 (7DDA / 7DD3)	SD550 V3 (7DD9 / 7DD2)	SR670 V2 (7Z22 / 7Z23)	SR675 V3 (7D9Q / 7D9R)	SR680a V3 (7DHE)	SR685a V3 (7DHC)	ST250 V3 (7DCF / 7DCE)	SR250 V3 (7DCM / 7DCL)
4X67A86131	ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 4. Server support (Part 2 of 4)

Part Number	Description	Edge					Super Computing				1S Intel V2		2S Intel V2			
		SE350 (7Z46 / 7D1X)	SE350 V2 (7DA9)	SE360 V2 (7DAM)	SE450 (7D8T)	SE455 V3 (7DBY)	SD665 V3 (7D9P)	SD665-N V3 (7DAZ)	SD650 V3 (7D7M)	SD650-I V3 (7D7L)	SD650-N V3 (7D7N)	ST50 V2 (7D8K / 7D8J)	ST250 V2 (7D8G / 7D8F)	SR250 V2 (7D7R / 7D7Q)	ST650 V2 (7Z75 / 7Z74)	SR630 V2 (7Z70 / 7Z71)
4X67A86131	ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU	N	N	N	1	N	N	N	N	N	N	N	N	N	N	N

Table 5. Server support (Part 3 of 4)

Part Number	Description	AMD V1					Dense V2			4S V2	8S	4S V1		1S Intel V1						
		SR635 (7Y98 / 7Y99)	SR655 (7Y00 / 7Z01)	SR655 Client OS	SR645 (7D2Y / 7D2X)	SR665 (7D2W / 7D2V)	SD630 V2 (7D1K)	SD650 V2 (7D1M)	SD650-N V2 (7D1N)	SN550 V2 (7Z69)	SR850 V2 (7D31 / 7D32)	SR860 V2 (7Z59 / 7Z60)	SR950 (7X11 / 7X12)	SR850 (7X18 / 7X19)	SR850P (7D2F / 2D2G)	SR860 (7X69 / 7X70)	ST50 (7Y48 / 7Y50)	ST250 (7Y45 / 7Y46)	SR150 (7Y54)	SR250 (7Y52 / 7Y51)
4X67A86131	ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 6. Server support (Part 4 of 4)

Part Number	Description	2S Intel V1							Dense V1				
		ST550 (7X09 / 7X10)	SR530 (7X07 / 7X08)	SR550 (7X03 / 7X04)	SR570 (7Y02 / 7Y03)	SR590 (7X98 / 7X99)	SR630 (7X01 / 7X02)	SR650 (7X05 / 7X06)	SR670 (7Y36 / 7Y37)	SD530 (7X21)	SD650 (7X58)	SN550 (7X16)	SN850 (7X15)
4X67A86131	ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU	N	N	N	N	N	N	N	N	N	N	N	N

Software stack

The Flex Series GPU supports an open, flexible, standards-based software stack with oneAPI cross-architecture programming. The stack includes open source components and libraries, tools and frameworks so developers can create high-performance, cross-architecture media applications and solutions to meet a wide range of use cases. This open approach removes the barriers to proprietary models where code portability and the ability to adopt new architectures across multiple vendors is limited.

Intel enables the software ecosystem through industry collaborations, initiatives and standards bodies. It also provides ongoing leadership, investment and technical contributions to the open source community.

The common set of software capabilities integrates into popular middleware and frameworks, and the stack is delivered in validated productized containers or reference stacks. The containers can be orchestrated with Kubernetes on bare metal or in VMs using SR-IOV virtualization with tools to assign and manage workloads. The toolset is designed to speed time-to-market and enable flexible deployment of multiple workloads on the same GPU.

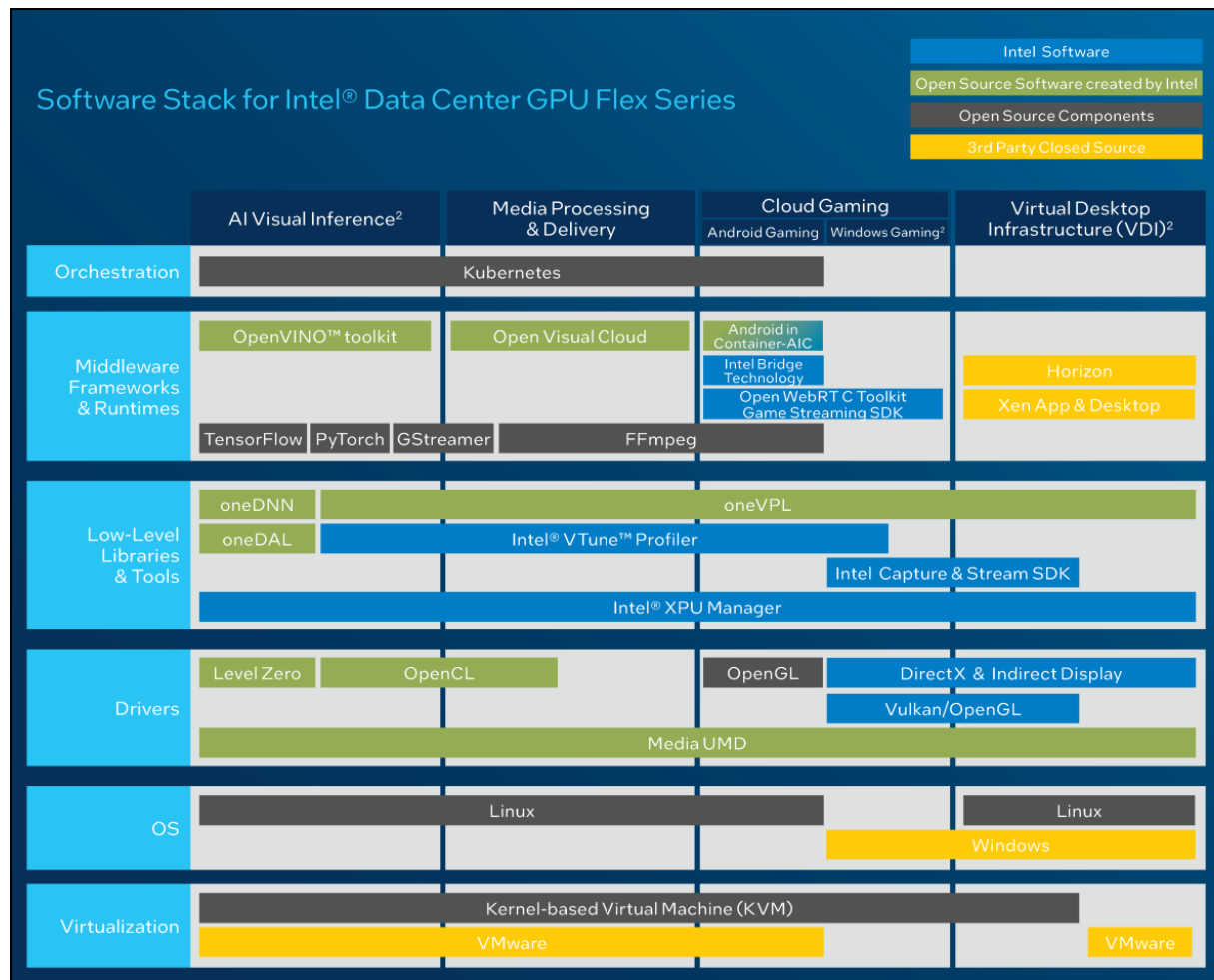


Figure 2. Software Stack for Intel Data Center GPU Flex Series (source: [intel.com](https://www.intel.com))

The following components are part of the Intel oneAPI Base Toolkit (individual tools can be downloaded separately):

- oneAPI Deep Neural Network Library (oneDNN)
- oneAPI Data Analytics Library (oneDAL)
- oneAPI Video Processing Library (oneVPL)
- Intel VTune Profiler

The following Intel-optimized tools are part of the Intel AI Analytics Toolkit:

- TensorFlow
- PyTorch

For more information about Intel oneAPI, see <https://intel.com/oneapi>

Operating system support

The following table lists the supported operating systems:

Tip: These tables are automatically generated based on data from [Lenovo ServerProven](#).

Table 7. Operating system support for ThinkSystem Intel Flex 170 16GB Gen4 Passive GPU, 4X67A86131

Operating systems	SE450
Microsoft Windows Server 2019	Y
Microsoft Windows Server 2022	Y
Red Hat Enterprise Linux 8.5	Y
Red Hat Enterprise Linux 8.6	Y
Ubuntu 20.04.5 LTS	Y
Ubuntu 22.04 LTS	Y
VMware vSphere Hypervisor (ESXi) 7.0 U3	Y
VMware vSphere Hypervisor (ESXi) 8.0	Y

Auxiliary power cables

The Flex 170 GPU option part number does not ship with auxiliary power cables. Cables are server-specific due to length requirements and the connector on the server end of the cable. For CTO orders, auxiliary power cables are derived by the configurator. For field upgrades, cables will need to be ordered separately as listed in the table below.

Table 8. Auxiliary power cables for the Flex 170 GPU

Auxiliary power cable needed with the SE450
<p>450mm cable Option: 4X97A90159, ThinkEdge SE450 Intel Flex 170 GPU Power Cable Feature: BZU3 SBB: SBB7A78275 Base: SC17B68639 FRU: 03LC071</p>

Operating environment

The Flex 170 GPU has the following operating characteristics:

- Ambient temperature
 - Operational: 0°C to 85°C
 - Storage: -40°C to 70°C
- Relative humidity:
 - Operational: 5 to 85%
 - Storage: 5 to 90%

Physical specifications

The Flex 170 GPU has the following physical specifications:

- Height: 111 mm (including edge connector)
- Length: 254 mm
- Width: 19 mm
- Weight: 806 g

Warranty

One year limited warranty. When installed in a Lenovo server, the GPU assumes the server's base warranty and any warranty upgrades.

Related publications

For more information, refer to these documents:

- ThinkSystem and ThinkAgile GPU Summary:
<https://lenovopress.lenovo.com/lp0768-thinksystem-thinkagile-gpu-summary>
- ServerProven compatibility:
<https://serverproven.lenovo.com/>
- Intel Data Center GPU Flex Series product page:
<https://www.intel.com/content/www/us/en/products/details/discrete-gpus/data-center-gpu/flex-series.html>
- Intel oneAPI:
<https://intel.com/oneapi>

Related product families

Product families related to this document are the following:

- [GPU adapters](#)

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